## 501959921 06/19/2012

### PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

### **CONVEYING PARTY DATA**

Name	Execution Date
Hiromi Hayashi	03/12/2012
Masatoshi Echigo	03/12/2012
Dai Oguro	03/12/2012

### RECEIVING PARTY DATA

Name:	MITSUBISHI GAS CHEMICAL COMPANY, INC.	
Street Address:	5-2, Marunouchi 2-chome, Chiyoda-ku	
City:	Tokyo	
State/Country:	JAPAN	
Postal Code:	100-8324	

#### PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13500715

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ATTORNEY DOCKET NUMBER: 9326-101471-US

NAME OF SUBMITTER: Stephen S. Favakeh

Total Attachments: 3

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> PATENT REEL: 028399 FRAME: 0018

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Attorney Docket 9326-101471-US

ASSIGNMENT

We, Hiromi Hayashi of Hiratsuka-shi, Kanagawa, Japan, Masatoshi ECHIGO of

Hiratsuka-shi, Kanagawa, Japan, and Dai OGURO of Tokyo, Japan, for good and valuable

consideration, receipt of which is hereby acknowledged, have assigned and do hereby assign to

MITSUBISHI GAS CHEMICAL COMPANY, INC., a Japanese company, having its principal

place of business at 5-2, Marunouchi 2-chome, Chiyoda-ku, Tokyo 100-8324 Japan, its successors,

assigns and legal representatives, the entire right, title and interest, in and to all subject matter

invented by us and disclosed in the application for Letters Patent of the United States entitled

CYCLIC COMPOUND, METHOD OF PRODUCING THE SAME, RADIATION SENSISTIVE

COMPOSITION, AND METHOD OF FORMING RESIST PATTERN

Application Number 13/500,715, filed April 6, 2012; and in and to all patent and all convention and

treaty rights of all kinds, including the right to claim priority from said application, and all

rights in and to any continuation, continuation-in-part, and divisional application therefrom,

and any reissue or re-examination as to any patent issuing therefrom, in all countries

throughout the world, for all such subject matter described therein, including all rights of action

and rights to recover damages for past infringements. We agree to sign all documents

necessary to secure all said patents and rights, and request issuance of all said patents to the

above assignee in accordance with this assignment.

March 12 , 2012

Hiromi Honyashi Hiromi Hayashi

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March 12	, 2012
PALCILIA	

Masaturhi Echigo
Masatoshi ECHIGO

March 12	, 2012

Dai Oguro

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